4 x 44 automotive LCD driver Rev. 2 — 29 September 2021

Product data sheet

# **1** General description

The PCA8546 is a peripheral device which generates the drive signals for any multiplexed LCD containing up to four backplanes, and up to 176 elements. The PCA8546 is compatible with most microcontrollers and communicates via the two-line bidirectional I<sup>2</sup>C-bus (PCA8546A) or a three line unidirectional SPI-bus (PCA8546B). Communication overheads are minimized using a display RAM with auto-incremented addressing.

For a selection of NXP LCD segment drivers, see <u>Table 37</u>.

# 2 Features and benefits

- AEC-Q100 grade 3 compliant for automotive applications
- Single-chip 176 elements LCD controller and driver
- Wide range for digital power supply: from 1.8 V to 5.5 V
- LCD supply range from 2.5 V up to 9 V
- LCD and logic supplies may be separated
- Low power consumption
- Four backplanes and selectable display bias configuration
- On-chip RAM for display data storage
- 400 kHz l<sup>2</sup>C-bus interface (PCA8546A)
- 5 MHz SPI-bus interface (PCA8546B)
- Programmable frame frequency in the range of 60 Hz to 300 Hz in steps of about 10 Hz; factory calibrated
- 176 segments driven allowing:
  - up to 22 7-segment alphanumeric characters
  - up to 11 14-segment alphanumeric characters
  - any graphics of up to 176 elements
- Manufactured in silicon gate CMOS process
- Extended operating temperature range up to 95 °C

# **3** Applications

- Climate control
- · Car radio
- Dashboard display



#### **Ordering information** 4

Table 1. Ordering information								
Type number	Interface type	Topside mark	Package	Package				
			Name	Description	Version			
PCA8546ATT/A	l <sup>2</sup> C-bus	PCA8546ATT	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1			
PCA8546BTT/A	SPI-bus	PCA8546BT1	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1			

# 4.1 Ordering options

#### Table 2. Ordering options

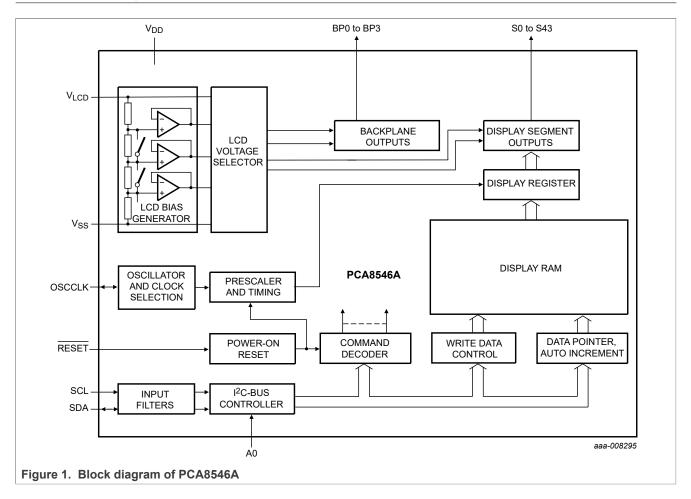
Type number	Orderable part number	Package	Packing method <sup>[1]</sup>	Minimum order quantity	Temperature
PCA8546ATT/A	PCA8546ATT/AJ <sup>[2]</sup>	TSSOP56	reel 13 inch q1 non dry pack	2000	$T_{amb}$ = -40 °C to +95 °C
	PCA8546ATT/AY	TSSOP56	reel 13 inch q1 dry pack	2000	$T_{amb}$ = -40 °C to +95 °C
PCA8546BTT/A	PCA8546BTT/AJ <sup>[3]</sup>	TSSOP56	reel 13 inch q1 non dry pack	2000	$T_{amb}$ = -40 °C to +95 °C
	PCA8546BTT/AY	TSSOP56	reel 13 inch q1 dry pack	2000	$T_{amb}$ = -40 °C to +95 °C

[1]

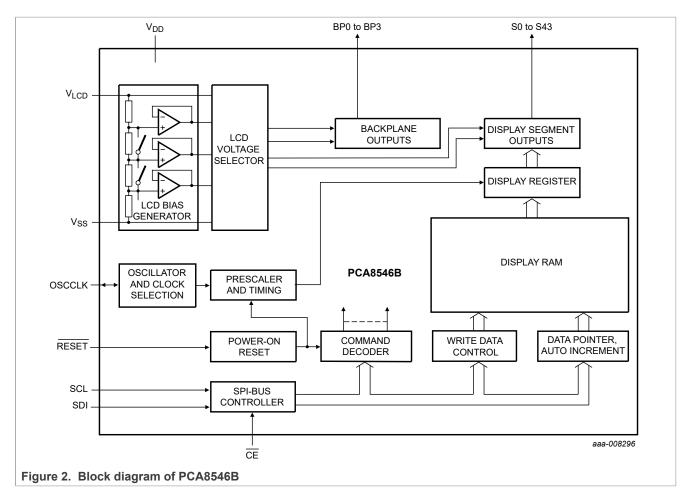
Standard packing quantities and other packaging data are available at <a href="http://www.nxp.com/packages/">www.nxp.com/packages/</a>. Discontinuation Notice 202107021DN - drop in replacement is PCA8546ATT/AY - this is documented in PCN202102010F01. Discontinuation Notice 202107021DN - drop in replacement is PCA8546BTT/AY - this is documented in PCN202102010F01. [2] [3]

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# 5 Block diagram



## 4 x 44 automotive LCD driver

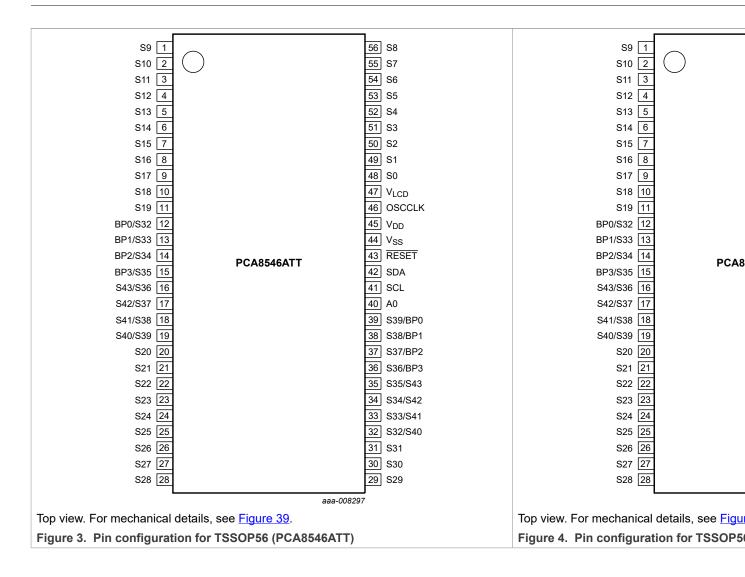


# 6 Pinning information

6.1 Pinning

PCA8546

## **NXP Semiconductors**



# 6.2 Pin description

Table 3. Pin description of PCA8546ATT and PCA8546BTTInput or input/output pins must always be at a defined level ( $V_{SS}$  or  $V_{DD}$ ) unless otherwisespecified.

Pin	Symbol		Туре	Description
1 to 11			output	LCD segment
20 to 31	S20 to S31	S20 to S31		LCD segment
43	RESET		input	active LOW reset input
44	V <sub>SS</sub>		supply	ground supply voltage
45	V <sub>DD</sub>		supply	supply voltage
46	OSCCLK		input/output	external clock input/internal oscillator output
47	V <sub>LCD</sub> <sup>[1]</sup>		supply	LCD supply voltage
48 to 56	S0 to S8		output	LCD segment
Pin layou	it depending on	backplane swa	ap configurat	ion <sup>[2]</sup>
	<b>BPS = 0</b> <sup>[3]</sup>	BPS = 1		
12	BP0	S32	output	LCD backplane/LCD segment
13	BP1	S33		
14	BP2	S34		
15	BP3	S35	1	
16	S43	S36	1	
17	S42	S37	]	
18	S41	S38		
19	S40	S39	]	
32	S32	S40		
33	S33	S41		
34	S34	S42		
35	S35	S43		
36	S36	BP3		
37	S37	BP2		
38	S38	BP1		
39	S39	BP0		
Pin layou	it depending on	product and b	us type	
	PCA8546ATT	PCA8546BTT		
40	A0		input	I <sup>2</sup> C-bus target address selection
		CE	input	SPI-bus chip enable - active LOW
41	SCL		input	l <sup>2</sup> C-bus serial clock
		SCL	input	SPI-bus serial clock

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Table 3. Pin description of PCA8546ATT and PCA8546BTT...continued

Input or input/output pins must always be at a defined level ( $V_{SS}$  or  $V_{DD}$ ) unless otherwise specified.

Pin	Symbol		Туре	Description
42	SDA		input/output	I <sup>2</sup> C-bus serial data
		SDI	input	SPI-bus data input

 $V_{LCD}$  must be equal to or greater than  $V_{DD}$ . [1]

Effect of backplane swapping is illustrated in Figure 5. [2] [3]

Bit BPS is explained in Section 7.1.3.

#### **Functional description** 7

The PCA8546 is a versatile peripheral device designed to interface any microcontroller to a wide variety of LCDs. It can directly drive any multiplexed LCD containing four backplanes and up to 44 segments.

# 7.1 Commands of PCA8546

The PCA8546 is controlled by 8 commands, which are defined in Table 4. Any other combinations of operation code bits that are not mentioned in this document may lead to undesired operation modes of PCA8546.

Command name	Register selection RS[1:0] <sup>[1]</sup>		Bits	Bits							Reference
			7	6	5	4	3	2	1	0	
initialize							1				Section 7.1.1
initialize-MSB	0	0	0	0	0	1	0	1	1	0	
initialize-LSB	0	0	0	0	0	0	0	0	1	1	
OTP-refresh	0	0	1	1	1	1	0	0	0	0	Section 7.1.2
mode-settings	0	0	0	1	0	1	BPS	INV	PD	E	Section 7.1.3
oscillator-control	0	0	0	0	0	1	1	EFR	COE	OSC	Section 7.1.4
set-bias-mode	0	0	0	0	0	0	0	1	B[1:0]		Section 7.1.5
frame-frequency	0	0	0	0	1	FD[4	FD[4:0]				Section 7.1.6
load-data-pointer	0	0	1	0	DP[5	DP[5:0]					Section 7.1.7
write-RAM-data	0	1	D[7:0							Section 7.1.8	

Table 4. Commands of PCA8546

[1] Information about control byte and register selection see Section 8.1.

#### 7.1.1 Command: initialize

This command generates a chip-wide reset. It consists of two bytes which have to be sent both to the device.

Table 5.	Initialize	- initialize	command	bit description
----------	------------	--------------	---------	-----------------

E	Bit	Symbol	Value	Description
I	nitialize	-MSB		

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Table 5. Initialize - initialize command bit description...continued

Bit	Symbol	Value	Description				
7 to 0	-	0001 0110	fixed value				
Initialize-LSB							
7 to 0	-	0000 0011	fixed value				

#### 7.1.2 Command: OTP-refresh

During production of the device, each IC is calibrated to achieve the specified accuracy of the frame frequency. This calibration is performed on EPROM cells called One Time Programmable (OTP) cells. The device reads these cells every time the OTP-refresh command is sent. The OTP-refresh command has to be sent after a reset has been made and before the display is enabled.

This command will be completed after a maximum of 30 ms and requires either the internal or external clock to run. If the internal oscillator is not used, then a clock must be supplied to the OSCCLK pin. If the OTP-refresh instruction is sent and no clock is present, then the request is stored until a clock is available.

**Remark:** It is recommended not to enter power-down mode during the OTP refresh cycle.

Table 6. OTP-refresh - OTP-refresh command bit description

Bit	Symbol	Value	Description
7 to 0	-	1111 0000	fixed value

#### 7.1.3 Command: mode-settings

Bit	Symbol	Value	Description
7 to 4	-	0101	fixed value
3	BPS		backplane swapping
		0 <sup>[1]</sup>	backplane configuration 0
		1	backplane configuration 1
2	INV		set inversion mode
		0 <sup>[1][2]</sup>	Driving scheme A: LCD line inversion mode
		1	Driving scheme B: LCD frame inversion mode
1	PD		set power mode
		1	power-down mode; backplane and segment outputs are connected to V <sub>SS</sub> and the internal oscillator is switched off
		0 <sup>[1]</sup>	power-up mode
0	E		display switch
		0 <sup>[1]</sup>	display disabled; backplane and segment outputs are connected to V <sub>SS</sub>
		1	display enabled

Table 7. Mode-settings - mode settings command bit description

PCA8546

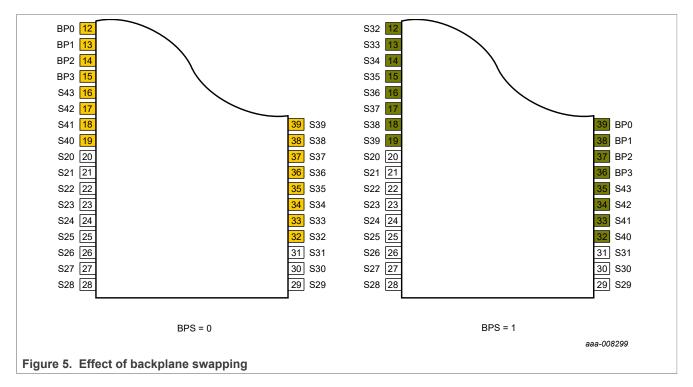
Product data sheet

- [1] Default value.
- [2] See <u>Section 7.1.3.2</u>.

#### 7.1.3.1 Backplane swapping

Backplane swapping can be configured with the BPS bit (see <u>Table 7</u>). It moves the location of the backplane and the associated segment outputs from one side of the PCA8546 to the other. Backplane swapping is sometimes desirable to aid with the routing of PCBs that do not use multiple layers.

The BPS bit has to be set to the required value before enabling the display. Failure to do so does not damage the PCA8546 or the display, however unexpected display content may appear.



#### 7.1.3.2 Line inversion (driving scheme A) and frame inversion (driving scheme B)

The DC offset of the voltage across the LCD is compensated over a certain period: linewise in line inversion mode (driving scheme A) or frame-wise in frame inversion mode (driving scheme B). With the INV bit (see <u>Table 7</u>), the compensation mode can be switched.

In frame inversion mode, the DC value is compensated across two frames and not within one frame. Changing the inversion mode to frame inversion reduces the power consumption; therefore it is useful when power consumption is a key point in the application.

Frame inversion may not be suitable for all applications. The RMS voltage across a segment is better defined; however, since the switching frequency is reduced, there is possibility for flicker to occur.

The waveforms of <u>Figure 14</u> shows the line inversion mode. <u>Figure 15</u> shows the frame inversion mode.

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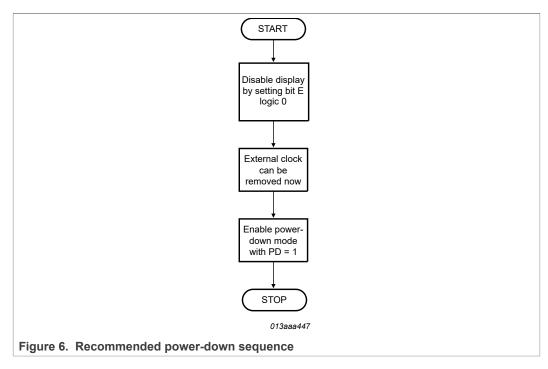
#### 7.1.3.3 Power-down mode

The power-down bit (PD) allows the PCA8546 to be put in a minimum power configuration. To avoid display artifacts, enter power-down only after the display has been switched off by setting bit E to logic 0. During power-down, the internal oscillator is switched off.

Table	8	Effect	of the	power-down	bit (	( <b>PD</b> )
lanc	υ.	LIICOL	or the	power-uowii	DIL	

Effect on function	Mode settings	Effect of setting PD		
		0	1	
backplane output	E = 1	normal function	V <sub>SS</sub>	
segment output	E = 1	normal function	V <sub>SS</sub>	
internal oscillator	OSC = 0, COE = 1	on	off	
OSCCLK pin	OSC = 0, COE = 1	output of internal oscillator frequency	V <sub>DD</sub>	
OSCCLK pin	OSC = 1	input clock	clock input, can be logic 0, logic 1, or left floating	

With the following sequence, the PCA8546 can be set to a state of minimum power consumption, called power-down mode.



#### **Remarks:**

• It is necessary to run the power-down sequence before removing the supplies. Depending on the application, care must be taken that no other signals are present at the chip input or output pins when removing the supplies (see <u>Section 9</u>). Otherwise it may cause unwanted display artifacts. If an uncontrolled removal of the supply happens, the PCA8546 does not get damaged.

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- Static voltages across the liquid crystal display can build up when the external LCD supply voltage ( $V_{LCD}$ ) is on while the IC supply voltage is off, or the other way around. This may cause unwanted display artifacts. To avoid such artifacts,  $V_{LCD}$  and  $V_{DD}$  must be applied or removed together.
- A clock signal must always be supplied to the device when the display is active. Removing the clock may freeze the LCD in a DC state, which is not suitable for the liquid crystal. First disable the display and afterwards remove the clock signal.

#### 7.1.3.4 Display enable

The display enable bit (E) is used to enable and disable the display. When the display is disabled, all LCD outputs go to  $V_{SS}$ . This function is implemented to ensure that no voltage can be induced on the LCD outputs as it may lead to unwanted displays of segments.

Recommended start-up sequences are found in Section 7.2.3

**Remark:** Display enable is not synchronized to an LCD frame boundary. Therefore using this function to flash a display for prolonged periods is not recommended due to the possible build-up of DC voltages on the display.

#### 7.1.4 Command: oscillator-control

The oscillator-control command switches between internal and external oscillator and enables or disables the pin OSCCLK. It is also defines the external frequency.

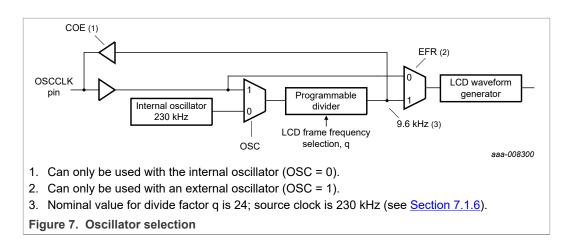
Bit	Symbol	Value	Description	
7 to 3	-	0001 1	fixed value	
2 EFR			external clock frequency applied on pin OSCCLK	
		0 <sup>[1]</sup>	9.6 kHz	
		1	230 kHz	
1	COE		clock output enable for pin OSCCLK	
		0 <sup>[1]</sup>	clock signal not available on pin OSCCLK; pin OSCCLK is in 3-state	
		1	clock signal available on pin OSCCLK	
0	OSC		oscillator source	
		0 <sup>[1]</sup>	internal oscillator running	
		1	external oscillator used; pin OSCCLK becomes an input; used in combination with EFR to determine input frequency	

Table 9. Oscillator-control - oscillator control command bit description

[1] Default value.

The bits OSC, COE, and EFR control the source and frequency of the clock used to generate the LCD signals (see Figure 7). Valid combinations are shown in <u>Table 10</u>.

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#### Table 10. Valid combinations of bits OSC, EFR, and COE

OSC	COE	EFR	OSCCLK pin	Clock source
0	0	not used	inactive; may be left floating	internal oscillator used
0	1	not used	output of internal oscillator frequency (prescaler)	internal oscillator used
1	not used	0	9.6 kHz input	OSCCLK pin
1	not used	1	230 kHz input	OSCCLK pin

Table 11. Typical use of bits OSC, EFR, and COE

Usage	OSC	COE	EFR
LCD with internal oscillator	0	0	not used
LCD with external oscillator (230 kHz)	1	not used	1
LCD with external oscillator (9.6 kHz)	1	not used	0

#### 7.1.4.1 Oscillator

The system is designed to operate from a 9.6 kHz or a 230 kHz clock. This clock can be sourced internally or externally. The internal logic and LCD drive signals of the PCA8546 are timed either by the internal oscillator or from the clock externally supplied.

#### Internal clock

When the internal oscillator is used, all LCD signals are generated from it. The oscillator runs at nominal 230 kHz. The relationship between this frequency and the LCD frame frequency is detailed in <u>Section 7.1.6</u>. Control over the internal oscillator is made with the OSC bit (see <u>Section 7.1.4</u>).

It is possible to make the internal oscillator signal available on pin OSCCLK by using the oscillator-control command (see <u>Table 9</u>) and configuring the clock output enable (COE) bit. If not required, the pin OSCCLK should be left open or connected to  $V_{SS}$ . At power-on the signal at pin OSCCLK is disabled and pin OSCCLK is in 3-state.

Clock output is only valid when using the internal oscillator. The signal appears on the OSCCLK pin.

An intermediate clock frequency is available at the OSCCLK pin. The duty cycle of this clock varies with the chosen divide ratio.

PD	OSC	COE	EFR	OSCCLK pin <sup>[1]</sup>
power-down	n.a.	off	n.a.	3-state <sup>[2]</sup>
power-down	n.a.	on	n.a.	V <sub>DD</sub>
power-up	internal oscillator	off	n.a.	3-state
		on	n.a.	9.6 kHz output <sup>[3]</sup>
	external oscillator	n.a.	9.6 kHz	9.6 kHz input
			230 kHz	230 kHz input

 Table 12. OSCCLK pin state depending on configuration

[1] When RESET is active, the pin OSCCLK is in 3-state.

[2] In this state, an external clock may be applied, but it is not a requirement.

[3] 9.6 kHz is the nominal frequency with q = 24, see <u>Table 13</u>.

External clock

In applications where an external clock must be applied to the PCA8546, bit OSC (see <u>Table 9</u>) has to be set logic 1. In this case pin OSCCLK becomes an input.

The OSCCLK signal must switch between the  $V_{\text{SS}}$  and the  $V_{\text{DD}}$  voltage supplied to the chip.

The EFR bit determines the external clock frequency (230 kHz or 9.6 kHz). The clock frequency ( $f_{clk(ext)}$ ) in turn determines the LCD frame frequency, see <u>Table 13</u>.

**Remark:** If an external clock is used, then this clock signal must always be supplied to the device when the display is on. Removing the clock may freeze the LCD in a DC state which damages the LCD material.

#### 7.1.4.2 Timing and frame frequency

The timing of the PCA8546 organizes the internal data flow of the device. This includes the transfer of display data from the display RAM to the display segment outputs. The timing also generates the LCD frame frequency which it derives as an integer division of the clock frequency (see <u>Table 13</u>). The frame frequency is a fixed division of the internal clock or of the frequency applied to pin OSCCLK when an external clock is used.

Table 13.	LCD	frame	frequencies
-----------	-----	-------	-------------

Frame frequency	Typical external frequency (Hz)	Nominal frame frequency (Hz)	EFR bit	Value of q <sup>[1]</sup>
$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48}$	9 600	200	0	-
$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48q}$	230 000	200	1	24

[1] Other values of the frame frequency prescaler see <u>Table 16</u>.

PCA8546 Product data sheet When the internal clock is used, or an external clock with EFR = 1, the LCD frame frequency can be programmed by software in steps of approximately 10 Hz in the range of 60 Hz to 300 Hz (see <u>Table 16</u>). Furthermore the internal oscillator is factory calibrated, see <u>Table 31</u>.

#### 7.1.5 Command: set-bias-mode

The set-bias-mode command allows setting the bias level.

Bit	Symbol	Value	Description
7 to 2	-	0000 01	fixed value
1 to 0	B[1:0]	00 <sup>[1]</sup> . 01	<sup>1</sup> ⁄ <sub>4</sub> bias
		11	¹∕₃ bias
		10	1/2 bias

Table 14. Set-bias-mode - set bias mode command bit description

[1] Default value.

#### 7.1.6 Command: frame-frequency

With the frame-frequency command, the frame frequency for the display can be configured. The clock frequency determines the frame frequency.

 Table 15. Frame-frequency - frame frequency and output clock frequency command bit description

Bit	Symbol	Value	Description
7 to 5	-	001	fixed value
4 to 0	FD[4:0]	see <u>Table 16</u>	frequency prescaler

When using an **external clock** it can be either a 230 kHz or a 9.6 kHz clock signal. The EFR bit (see <u>Table 9</u>) has to be set according to the external clock frequency.

When EFR is set to 9.6 kHz, then the LCD frame frequency is calculated with Equation 1:

$$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48}$$
(1)

When EFR is set to 230 kHz, then the LCD frame frequency is calculated with Equation 2:

$$f_{fr(LCD)} = \frac{f_{clk(ext)}}{48q}$$
(2)

where q is the frequency divide factor (see Table 16).

**Remark:** f<sub>clk(ext)</sub> is the external input clock frequency to pin OSCCLK.

When the **internal oscillator** is used, the intermediate frequency may be output on the OSCCLK pin. Its frequency is given in <u>Table 16</u>.

Table 16. Frame frequency prescaler values for 230 kHz clock operation

	Nominal LCD frame frequency (Hz) <sup>[1]</sup>		Intermediate clock frequency (Hz)
0 0000	59.9	80	2 875

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FD[4:0]	Nominal LCD frame frequency (Hz) <sup>[1]</sup>	Divide factor, q	Intermediate clock frequency (Hz)
0 0001	70.5	68	3 382
0 0010	79.9	60	3 833
0 0011	90.4	53	4 340
0 0100	99.8	48	4 792
0 0101	108.9	44	5 227
0 0110	119.8	40	5 750
0 0111	129.5	37	6 216
0 1000	140.9	34	6 765
0 1001	149.7	32	7 188
0 1010	159.7	30	7 667
0 1011	171.1	28	8 2 1 4
0 1100	177.5	27	8 519
0 1101	191.7	25	9 200
0 1110 <sup>[2]</sup>	199.7	24	9 583
0 1111	208.3	23	10 000
1 0000	217.8	22	10 455
1 0001	228.3	21	10 952
1 0010	239.6	20	11 500
1 0011	252.2	19	12 105
1 0100	266.2	18	12 778
1 0101	281.9	17	13 529
1 0110	299.5	16	14 375
1 0111 to 1 1111	not used		1

Table 16 Frame fraguency proceeder values for 220 kHz clock exerction ... .

[1] [2] Nominal frame frequency calculated for the default clock frequency of 230 kHz.

Default value.

#### 7.1.7 Command: load-data-pointer

The load-data-pointer command defines the start address of the display RAM, see Table 17. The data pointer is auto incremented after each RAM write.

Table 17. Load-data-pointer - load data pointer command bit d	escription
Table III Boad data pointer Toda data pointer command sit a	ocomption

Bit	Symbol	Value	Description
7 to 6	-	10	fixed value
5 to 0	DP[5:0]	00 0000 <sup>[1]</sup> to 10 1011	6-bit binary value of 0 to 43

[1] Default value.

**Remark:** Data pointer values outside of the valid range are ignored and no RAM content is transferred until a valid data pointer value is set.

Filling of the display RAM is described in <u>Section 7.9</u>.

#### 7.1.8 Command: write-RAM-data

This command initiates the transfer of data to the display RAM. Data is written into the address defined by the load-data-pointer command. RAM filling is described in <u>Section 7.9</u>.

 Table 18. Write-RAM-data - write RAM data command bit description

 For this command to be effective bit RS[1:0] of the control byte has to be set logic 01, see

 Table 22on page 29.

Bit	Symbol	Value	Description
7 to 0	D[7:0]	0000 0000 to 1111 1111	writing data byte-wise to RAM

## 7.2 Start-up and shut-down

#### 7.2.1 Reset and Power-On Reset (POR)

After power-on the PCA8546 has to be initialized by sending the two bytes of the initialize command (see <u>Section 7.1.1</u> and <u>Table 5</u>).

After a reset and the initialization the starting conditions of the PCA8546 are as follows:

- 1. The display is disabled.
- 2. All backplane and segment outputs are set to  $V_{SS}$ .
- 3. The data pointers are cleared (set logic 0).
- 4. RAM data is not initialized. Its content can be considered to be random.
- 5. The internal oscillator is running; no clock signal is available on pin OSCCLK; pin OSCCLK is in 3-state.

The state after a reset and the initialization is shown in <u>Table 19</u>.

#### Table 19. Starting conditions

Associated command	Bits							
	7	6	5	4	3	2	1	0
mode-settings	-	-	-	-	BPS = 0	INV = 0	PD = 0	E = 0
oscillator-control	-	-	-	-	-	EFR = 0	COE = 0	OSC = 0
set-bias-mode	-	-	-	-	-	-	B[1:0] = 00	
frame-frequency	-	-	- FD[4:0] = 0 1110					
load-data-pointer	-	-	DP[5:0] = 00 0000					

After Power-On Reset (POR) and the initialize command and before enabling the display, the RAM content should be brought to a defined state by writing meaningful content (for example, a graphic) otherwise unwanted display artifacts may appear on the display.

#### 7.2.2 RESET pin function

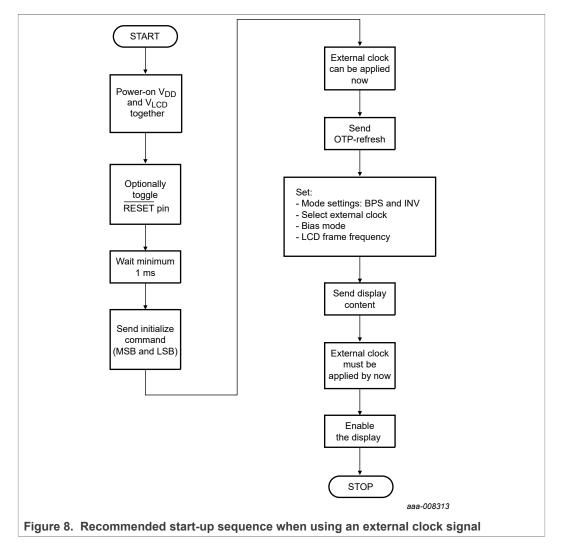
The RESET pin sets the PCA8546 in a defined mode. The RAM content remains unchanged. After the reset signal is removed, the initialize command (see <u>Section 7.1.1</u> and <u>Table 5</u>) has to be sent to the PCA8546. See <u>Section 7.2.1</u> for details.

#### 7.2.3 Recommended start-up sequences

This chapter describes how to proceed with the initialization of the chip in different application modes.

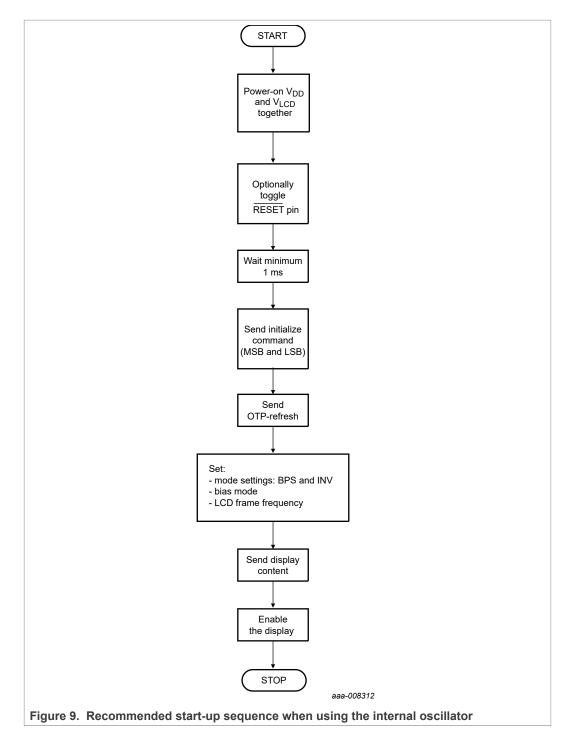
In general, the sequence should always be:

- 1. Power-on or reset the device,
- 2. send the initialize command,
- 3. set the display and functional modes,
- 4. fill the display memory and then
- 5. turn on the display.



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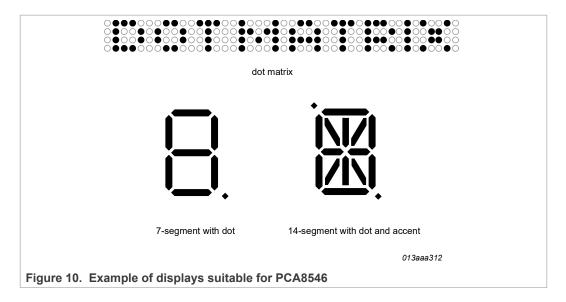
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# 7.3 Possible display configurations

The PCA8546 is a versatile peripheral device designed to interface between any microcontroller to a wide variety of LCD segment or dot matrix displays (see Figure 10). It can drive multiplexed LCD with 4 backplanes and up to 44 segments.

## 4 x 44 automotive LCD driver



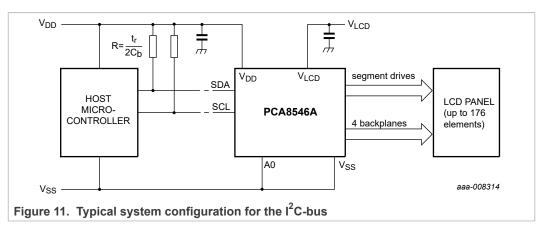
#### Table 20. Display configuration

Number of			Digits/Characte	Dot matrix/	
Backplanes	Segments	Icons	7 segment <sup>[1]</sup>	14 segment <sup>[2]</sup>	Elements
4	44	176	22	11	176

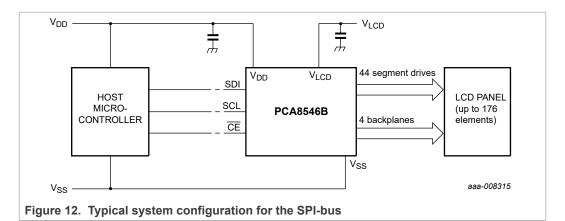
[1]

7 segment display has 8 elements including the decimal point. 14 segment display has 16 elements including decimal point and accent dot. [2]

The display configuration in Table 20 can be implemented in the typical systems shown in Figure 11 and Figure 12.



4 x 44 automotive LCD driver



The host microcontroller maintains the two line  $I^2C$ -bus or a three line SPI-bus communication channel with the PCA8546. The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the power supplies (V<sub>DD</sub>, V<sub>SS</sub>, V<sub>LCD</sub>) and the LCD panel selected for the application.

The minimum recommended values for external capacitors on V<sub>DD</sub> and V<sub>LCD</sub> are 100 nF respectively. Decoupling of V<sub>LCD</sub> helps to reduce display artifacts. The decoupling capacitors should be placed close to the IC with short connections to the respective supply pin and V<sub>SS</sub>.

## 7.4 LCD voltage selector

The LCD voltage selector coordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by the set-bias-mode command (see <u>Table 14</u>).

Fractional LCD biasing voltages are obtained from an internal voltage divider. The biasing configurations, the biasing characteristics as functions of  $V_{LCD}$  and the resulting discrimination ratios (D), are given in Table 21.

Discrimination is a term which is defined as the ratio of the on and off RMS voltage across a segment. It can be thought of as a measurement of contrast.

LCD multiplex			LCD bias	V <sub>of f</sub> (RMS)	V <sub>on(RMS)</sub>	$D = \frac{V_{on(RMS)}}{[1]}$	V <sub>LCD</sub> <sup>[2]</sup>
drive mode			configuration V <sub>LCD</sub>		$V_{LCD}$ $D = V_{off(RMS)}$		
1:4 <sup>[3]</sup>	4	3	1/2	0.433	0.661	1.527	2.309V <sub>off(RMS)</sub>
1:4	4	4	1/3	0.333	0.577	1.732	3.0V <sub>off(RMS)</sub>
1:4 <sup>[3]</sup>	4	5	1⁄4	0.331	0.545	1.646	3.024V <sub>off(RMS)</sub>

Table 21. Preferred LCD drive modes: summary of characteristics

[1] Determined from Equation 5.

[2] Determined from Equation 4.

[3] In these examples, the discrimination factor and hence the contrast ratios are smaller. The advantage of these LCD drive modes is a reduction of the LCD voltage V<sub>LCD</sub>.

A practical value for V<sub>LCD</sub> is determined by equating V<sub>off(RMS)</sub> with a defined LCD threshold voltage (V<sub>th(off)</sub>), typically when the LCD exhibits approximately 10 % contrast.

Bias is calculated by  $\frac{1}{1+a}$ , where the values for a are

a = 1 for  $\frac{1}{2}$  bias a = 2 for  $\frac{1}{3}$  bias a = 3 for  $\frac{1}{4}$  bias

The RMS on-state voltage (Von(RMS)) for the LCD is calculated with Equation 3

$$V_{on(RMS)} = \frac{V_{LCD}}{\sqrt{\frac{a^2+2a+n}{nx(1+a)^2}}}$$
 (3)

where  $V_{LCD}$  is the resultant voltage at the LCD segment and where the value for n is

n = 4 for 1:4 multiplex drive

The RMS off-state voltage (V<sub>off(RMS)</sub>) for the LCD is calculated with Equation 4:

$$V_{off(RMS)} = \frac{V_{LCD}}{\sqrt{\frac{a^2 - 2a + n}{n \times (1 + a)^2}}}$$
 (4)

Discrimination is the ratio of  $V_{on(RMS)}$  to  $V_{off(RMS)}$  and is determined from Equation 5:

$$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{a^2 + 2a + n}{a^2 - 2a + n}}$$
(5)

V<sub>LCD</sub> is sometimes referred to as the LCD operating voltage.

#### 7.4.1 Electro-optical performance

Suitable values for  $V_{\text{on}(\text{RMS})}$  and  $V_{\text{off}(\text{RMS})}$  are dependent on the LCD liquid used. The RMS voltage, at which a pixel gets switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at  $V_{th(off)}$ ) and the other at 90 % relative transmission (at  $V_{th(on)}$ ), see Figure 13. For a good contrast performance, the following rules should be followed:

 $V_{on(RMS)} \ge V_{th(on)}$  (6)

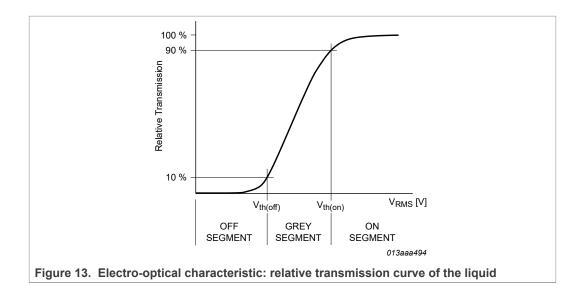
$$V_{off(RMS)} \leq V_{th(off)}(7)$$

 $V_{on(RMS)}$  and  $V_{off(RMS)}$  are properties of the display driver and are affected by the selection of a, n (see Equation 3 to Equation 5) and the  $V_{LCD}$  voltage.

 $V_{th(off)}$  and  $V_{th(on)}$  are properties of the LCD liquid and can be provided by the module manufacturer.  $V_{th(off)}$  is sometimes named  $V_{th}$ .  $V_{th(on)}$  is sometimes named saturation voltage  $V_{sat}$ .

It is important to match the module properties to those of the driver in order to achieve optimum performance.

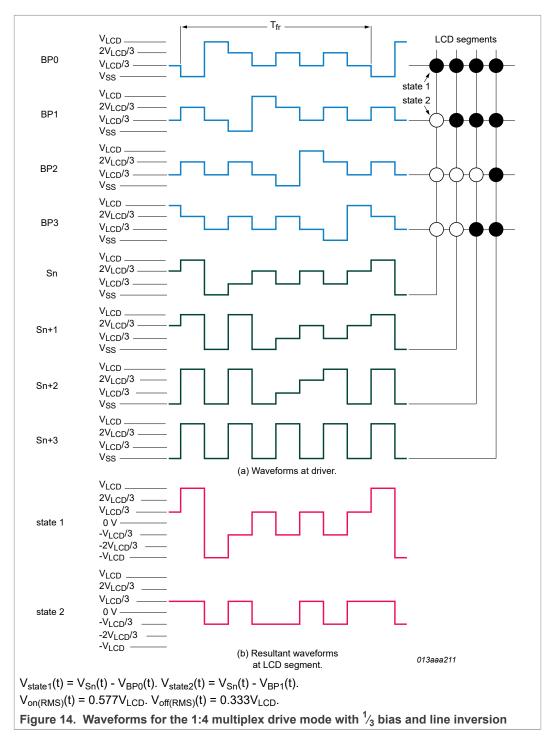
4 x 44 automotive LCD driver



4 x 44 automotive LCD driver

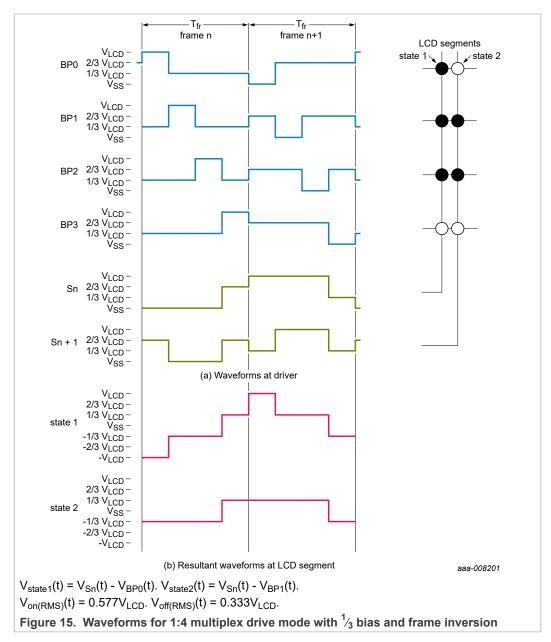
# 7.5 LCD drive mode waveforms

# 7.5.1 $\frac{1}{3}$ bias and line inversion



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# 7.5.2 $\frac{1}{3}$ bias and frame inversion

#### 7.6 Display register

The display register holds the display data while the corresponding multiplex signals are generated.

## 7.7 Backplane outputs

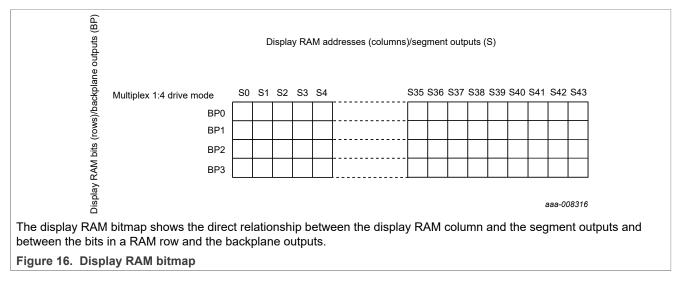
The LCD drive section includes four backplane outputs: BP0 to BP3 which must be connected directly to the LCD.

#### 7.8 Segment outputs

The LCD drive section includes up to 44 segment outputs (S0 to S43) which must be connected directly to the LCD. The segment output signals are generated based on the data resident in the display register. When less segment outputs are required, the unused segment outputs must be left open-circuit.

## 7.9 Display RAM

The display RAM stores the LCD data. The RAM size is 44 × 4 bit.



Logic 1 in the RAM bit map indicates the on-state ( $V_{on(RMS)}$ ) of the corresponding LCD element; similarly, logic 0 indicates the off-state ( $V_{off(RMS)}$ ). For more information on  $V_{on(RMS)}$  and  $V_{off(RMS)}$ , see Section 7.4.

There is a one-to-one correspondence between

- the bits in the RAM bitmap and the LCD elements,
- the RAM columns and the segment outputs,
- the RAM rows and the backplane outputs.

The display RAM bit map, Figure 16, shows row 0 to row 3 and column 0 to column 43. Row 0 to row 3 correspond with the backplane outputs BP0 to BP3. Column 0 to column 43 correspond with the segment outputs S0 to S43. In multiplexed LCD applications, the data of each row of the display RAM is time-multiplexed with the corresponding backplane (row 0 with BP0, row 1 with BP1, and so on).

#### 7.9.1 Data pointer

The addressing mechanism for the display RAM is realized using the data pointer. This allows the loading of an individual display data byte, or a series of display data bytes, into any location of the display RAM. The sequence commences with the initialization of the data pointer by the load-data-pointer command (see <u>Table 17</u>).

Following this command, an arriving data byte is stored starting at the display RAM address indicated by the data pointer.

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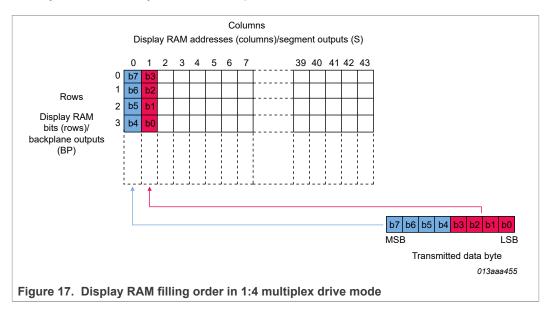
The data pointer is automatically incremented. That is, after each byte is stored, the contents of the data pointer are incremented by two.

When the address counter reaches the end of the RAM, it stops incrementing after the last byte is transmitted. Redundant bits of the last byte and subsequent bytes transmitted are discarded until the pointer is reset. To send new RAM data, the data pointer must be reset.

If an I<sup>2</sup>C-bus or SPI-bus data access is terminated early, then the state of the data pointer is unknown. The data pointer must then be rewritten before further RAM accesses.

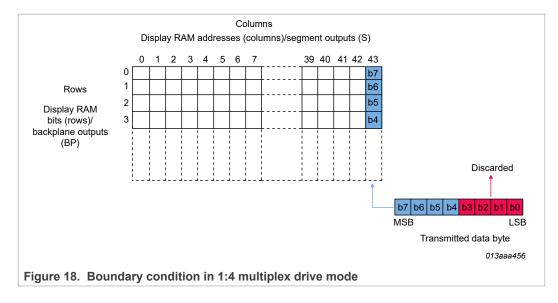
#### 7.9.2 RAM filling

The RAM is organized in four rows and 44 columns. The eight transmitted data bits are placed in two successive display RAM columns of four rows (see Figure 17). In order to fill the whole four RAM rows, 22 bytes need to be sent to the PCA8546. After the last byte sent, the data pointer must be reset before the next RAM content update. Additional data bytes sent and any data bits that spill over the RAM are discarded.



Depending on the start address of the data pointer, there is the possibility for a boundary condition. This occurs when more data bits are sent than fit into the remaining RAM. The additional data bits are discarded. See Figure 18.

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## 8 Bus interfaces

# 8.1 Control byte and register selection

After initiating the communication over the bus and sending the target address (I<sup>2</sup>C-bus, see <u>Section 8.2</u>) or subaddress (SPI-bus, see <u>Section 8.3</u>), a control byte follows. The purpose of this byte is to indicate both, the content for the following data bytes (RAM, or command) and to indicate that more control bytes will follow.

Typical sequences could be:

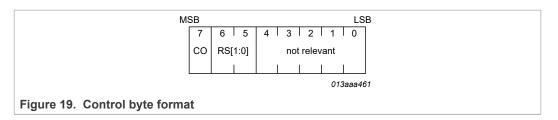
- target address/subaddress control byte command byte command byte command byte end
- target address/subaddress control byte RAM byte RAM byte RAM byte end
- target address/subaddress control byte command byte control byte RAM byte end

In this way, it is possible to send a mixture of RAM and command data in one access or alternatively, to send just one type of data in one access.

Bit	Symbol	Value	Description
7	СО		continue bit
		0	last control byte
		1	control bytes continue
6 to 5	RS[1:0]		register selection
		00	command register
		01	RAM data
		10, 11	unused
4 to 0	-	-	unused

Table 22.	Control	<b>b</b> yte	description	

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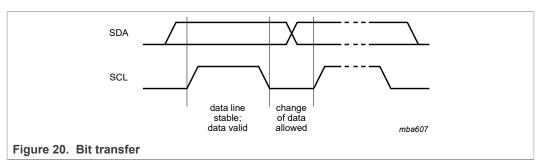


# 8.2 I<sup>2</sup>C-bus interface

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

## 8.2.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time is interpreted as a control signal (see Figure 20).



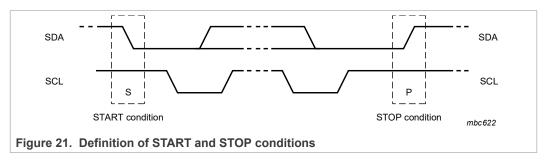
#### 8.2.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy.

A HIGH-to-LOW change of the data line, while the clock is HIGH, is defined as the START condition (S).

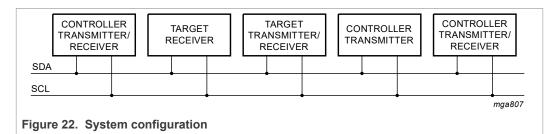
A LOW-to-HIGH change of the data line, while the clock is HIGH, is defined as the STOP condition (P).

The START and STOP conditions are shown in Figure 21.



#### 8.2.3 System configuration

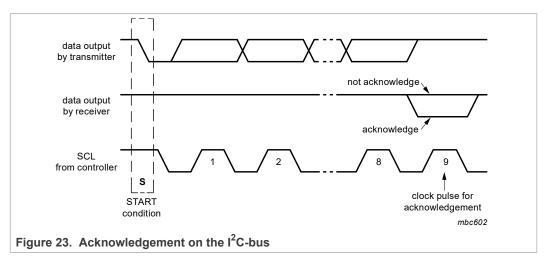
A device generating a message is a transmitter, a device receiving a message is the receiver. The device that controls the message is the controller and the devices which are controlled by the controller are the targets. The system configuration is shown in Figure 22.



#### 8.2.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of 8 bits is followed by an acknowledge cycle.

- A target receiver which is addressed must generate an acknowledge after the reception of each byte.
- Also a controller receiver must generate an acknowledge after the reception of each byte that has been clocked out of the target transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be considered).
- A controller receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the target. In this event, the transmitter must leave the data line HIGH to enable the controller to generate a STOP condition.



Acknowledgement on the  $I^2$ C-bus is shown in Figure 23.

## 8.2.5 I<sup>2</sup>C-bus controller

The PCA8546 acts as an  $I^2$ C-bus target receiver. It does not initiate  $I^2$ C-bus transfers or transmit data to an  $I^2$ C-bus controlller receiver. Device selection depends on the  $I^2$ C-bus target address.

#### 8.2.6 Input filters

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

## 8.2.7 I<sup>2</sup>C-bus target address

Device selection depends on the  $I^2$ C-bus target address. Two different  $I^2$ C-bus target addresses can be used to address the PCA8546 (see <u>Table 23</u>).

#### Table 23. I<sup>2</sup>C target address byte

	target address							
Bit	7	6	5	4	3	2	1	0
	MSB	-						LSB
	0	1	1	1	0	0	A0	R/W

The least significant bit of the target address byte is bit R/W (see Table 24).

#### Table 24. R/W-bit description

R/W	Description
0	write data
1	read data

Bit 1 of the target address is defined by connecting the input A0 to either  $V_{SS}$  (logic 0) or  $V_{DD}$  (logic 1). Therefore, two instances of PCA8546 can be distinguished on the same  $I^2C$ -bus.

# 8.2.8 I<sup>2</sup>C-bus protocol

The I<sup>2</sup>C-bus protocol is shown in Figure 24. The sequence is initiated with a START condition (S) from the I<sup>2</sup>C-bus controller which is followed by one of the two PCA8546 target addresses available. All PCA8546 with the corresponding A0 level acknowledge in parallel to the target address. But any PCA8546 with the alternative A0 level ignore the whole I<sup>2</sup>C-bus transfer.

After acknowledgement, a control byte follows (see <u>Section 8.1</u>).

The display bytes are stored in the display RAM at the address specified by the RAM data pointer.

The acknowledgement after each byte is made only by the addressed PCA8546. After the last data byte, the  $I^2$ C-bus controller issues a STOP condition (P). Alternatively a START may be issued to RESTART an  $I^2$ C-bus access.

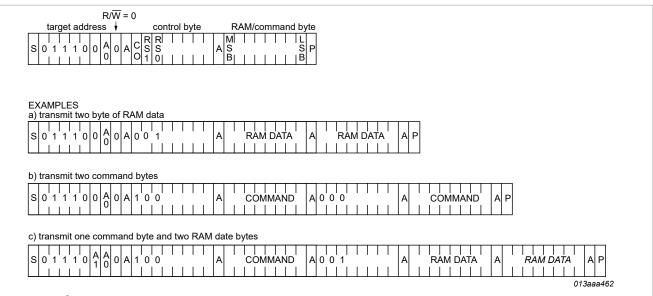


Figure 24. I<sup>2</sup>C-bus protocol write mode

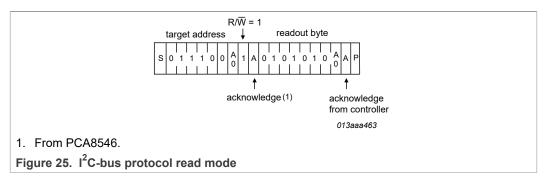
#### 8.2.8.1 Status read out

Status read out for  $I^2C$ -bus operation only. This command initiates the read-out of a fixed value plus the target address bit A0 from the PCA8546. The read-out function allows the  $I^2C$  controller to confirm the existence of the device on the  $I^2C$ -bus.

#### Table 25. Status read out value

Bit	Symbol	Value	Description
7 to 1	-	0101 010	fixed value
0	A0	0	read back value is 0101 0100
		1	read back value is 0101 0101

If a readout is made, the R/W bit must be logic 1 and then the next data byte following is provided by the PCA8546 as shown in Figure 25.



In the unlikely case that the chip has entered the internal test mode, detection of this state is possible by using the modified status read-out detailed in <u>Table 26</u>. The read out value is modified to indicate that the chip has entered an internal test mode.

Bit	Symbol Value		Description
DIL	Symbol	value	Description
7 to 1	-	1111 000	fixed value
0	A0	0	read back value is 1111 0000
		1	read back value is 1111 0001

Table 26. Modified status read out value

#### EMC detection

The PCA8546 is ruggedized against EMC susceptibility; however it is not possible to cover all cases. To detect if a severe EMC event has occurred, it is possible to check the responsiveness of the device by reading its register.

#### 8.3 SPI-bus interface

Data transfer to the device is made via a 3 line SPI-bus (see <u>Table 27</u>). There is no output data line. The SPI-bus is initialized whenever the chip enable line pin  $\overline{CE}$  is inactive.

Table	27.	Serial	interface

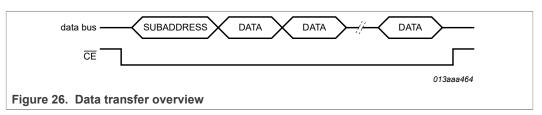
Symbol	Function	Description
CE	chip enable input <sup>[1]</sup> ; active LOW	when HIGH, the interface is reset
SCL	serial clock input	input may be higher than V <sub>DD</sub>
SDI	serial data input	input may be higher than $V_{\text{DD}}$ ; input data is sampled on the rising edge of SCL

[1] The chip enable must not be wired permanently LOW.

#### 8.3.1 Data transmission

The chip enable signal is used to identify the transmitted data. Each data transfer is a byte with the Most Significant Bit (MSB) sent first.

The transmission is controlled by the active LOW chip enable signal  $\overline{CE}$ . The first byte transmitted is the subaddress byte.



The subaddress byte opens the communication with a read/write bit and a subaddress. The subaddress is used to identify multiple devices on one SPI-bus.

Table 28. Subaddress byte definition

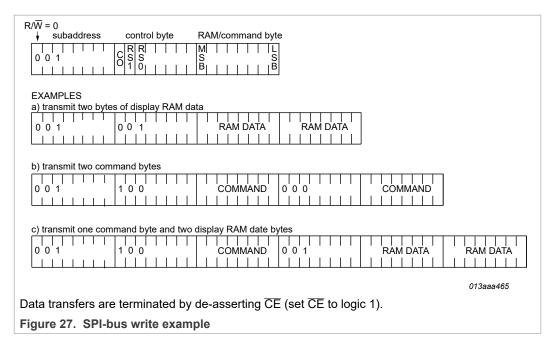
Bit	Symbol	Value	Description
7	R/W		data read or write selection
		0	write data
		1	read data

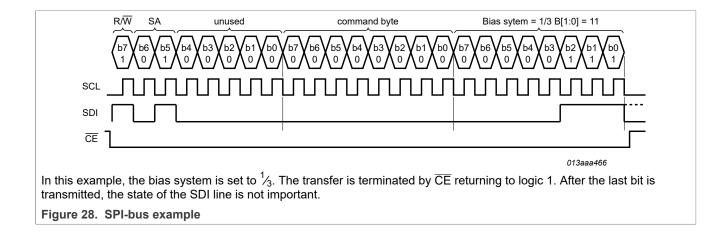
#### 4 x 44 automotive LCD driver

Table 28. Subaddress byte definition...continued

	· · · · · · · · · · · · · · · · · · ·		
Bit	Symbol	Value	Description
6 to 5	SA[1:0]	01	<b>subaddress</b> ; other codes cause the device to ignore data transfer
4 to 0	-		unused

After the subaddress byte, a control byte follows (see <u>Section 8.1</u>).

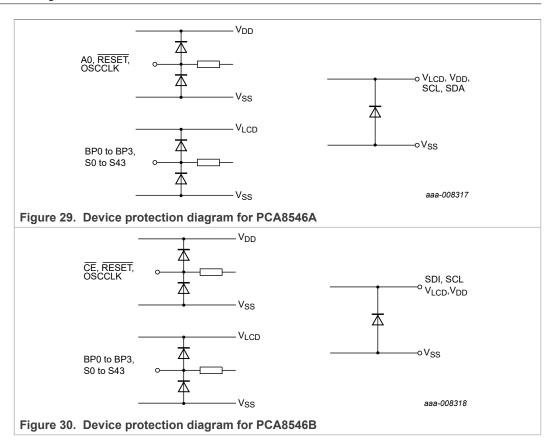




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# 9 Internal circuitry



# 10 Safety notes

# CAUTION This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

#### CAUTION



Static voltages across the liquid crystal display can build up when the LCD supply voltage ( $V_{LCD}$ ) is on while the IC supply voltage ( $V_{DD}$ ) is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts,  $V_{LCD}$  and  $V_{DD}$  must be applied or removed together.

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# 11 Limiting values

#### Table 29. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V <sub>DD</sub>	supply voltage			-0.5	+6.5	V
I <sub>DD</sub>	supply current			-50	+50	mA
V <sub>LCD</sub>	LCD supply voltage			-0.5	+10	V
I <sub>DD(LCD)</sub>	LCD supply current			-50	+50	mA
VI	input voltage	PCA8546ATT				
		on pins SDA, OSCCLK, SCL, A0, RESET		-0.5	+6.5	V
		PCA8546BTT				
		on pins CE, OSCCLK, SCL, SDI, RESET		-0.5	+6.5	V
I <sub>I</sub>	input current			-10	+10	mA
Vo	output voltage	on pins S0 to S43, BP0 to BP3		-0.5	+10	V
		on pin SDA		-0.5	+6.5	V
lo	output current			-10	+10	mA
I <sub>SS</sub>	ground supply current			-50	+50	mA
P <sub>tot</sub>	total power dissipation			-	400	mW
P/out	power dissipation per output			-	100	mW
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ	[1]	-	±3 500	V
		CDM	[2]	-	±1 250	V
l <sub>lu</sub>	latch-up current		[3]	-	200	mA
T <sub>stg</sub>	storage temperature		[4]	-65	+150	°C
T <sub>amb</sub>	ambient temperature	operating device		-40	+95	°C

[1] [2]

Pass level; Human Body Model (HBM), according to [1]. Pass level; Charge Device Model (CDM), according to [2]. Pass level; latch-up testing according to [3] at maximum ambient temperature (T<sub>amb(max)</sub>). According to the store and transport requirements (see [4]) the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to [3] [4] 75 %.

# 12 Static characteristics

#### Table 30. Static characteristics

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 9 V;  $T_{amb}$  = -40 °C to +95 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supplies		· · · · ·			1	_
V <sub>DD</sub>	supply voltage		1.8	-	5.5	V
PCA8546	All inform	nation provided in this document is subject to	legal disclaimers.		© NXP B.V. 2021. A	ll rights reserved

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#### Table 30. Static characteristics...continued

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 9 V;  $T_{amb}$  = -40 °C to +95 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>LCD</sub>	LCD supply voltage	$V_{LCD} \ge V_{DD}$		2.5	-	9	V
I <sub>DD(pd)</sub>	power-down mode supply current		[1]	-	0.5	2	μA
I <sub>DD</sub>	supply current	see Figure 31					
		external 9.6 kHz clock	[2]	-	10	25	μA
		internal oscillator	[2]	-	30	60	μA
I <sub>DD(LCD)</sub>	LCD supply current	power-down, see Figure 32	[1][3]	-	7	15	μA
		display active, see Figure <u>33</u>	[4]	-	55	140	μA
Logic		'				I	
VI	input voltage			V <sub>SS</sub> - 0.5	-	V <sub>DD</sub> + 0.5	V
V <sub>IL</sub>	LOW-level input voltage	on pins OSCCLK, A0 and RESET		-	-	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage	on pins OSCCLK, A0 and RESET		0.7V <sub>DD</sub>	-	-	V
Vo	output voltage			-0.5	-	V <sub>DD</sub> + 0.5	V
V <sub>OH</sub>	HIGH-level output voltage	driving load of 50 µA on pins OSCCLK		0.8V <sub>DD</sub>	-	-	V
V <sub>OL</sub>	LOW-level output voltage	driving load of 50 µA on pins OSCCLK		-	-	0.2V <sub>DD</sub>	V
I <sub>OH</sub>	HIGH-level output current	output source current; V <sub>OH</sub> = V <sub>DD</sub> - 0.4 V					
		on pin OSCCLK					
		V <sub>DD</sub> = 1.8 V		0.7	1.6	-	mA
		V <sub>DD</sub> ≥ 3.3 V		1.5	4.0	-	mA
I <sub>OL</sub>	LOW-level output current	output sink current; V <sub>OL</sub> = 0.4 V					
		on pin OSCCLK					
		V <sub>DD</sub> = 1.8 V		3	4	-	mA
		V <sub>DD</sub> ≥ 3.3 V		5	10	-	mA
IL	leakage current	V <sub>i</sub> = V <sub>DD</sub> or V <sub>SS</sub> ; on pin OSCCLK		-1	-	+1	μA
I <sup>2</sup> C-bus <sup>[5]</sup>			1	1			
On pins S	CL and SDA						
VI	input voltage			V <sub>SS</sub> - 0.5	-	5.5	V
V <sub>IL</sub>	LOW-level input voltage			-	-	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage			0.7V <sub>DD</sub>	-	-	V
Vo	output voltage			-0.5	_	+5.5	V

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#### Table 30. Static characteristics...continued

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 9 V;  $T_{amb}$  = -40 °C to +95 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
۱ <sub>L</sub>	leakage current	$V_{I} = V_{DD}$ or $V_{SS}$		-1	-	+1	μA
On pin SD	Ą					1	
I <sub>OL</sub>	LOW-level output current	output sink current					
		V <sub>DD</sub> = 1.8 V		3	5.5	-	mA
		V <sub>DD</sub> = 3.3 V		5	9	-	mA
SPI-bus		· · · ·				·	
V <sub>I</sub> ir	input voltage	on pin SCL		V <sub>SS</sub> - 0.5	-	5.5	V
		on pins $\overline{CE}$ and SDI		V <sub>SS</sub> - 0.5	-	V <sub>DD</sub> + 0.5	V
On pins SC	CL, CE and SDI		1	1		1	
V <sub>IL</sub>	LOW-level input voltage			-	-	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage			0.7V <sub>DD</sub>	-	-	V
IL .	leakage current	$V_{I} = V_{DD}$ or $V_{SS}$		-1	-	+1	μA
LCD outpu	uts				1	1	
ΔV <sub>O</sub>	output voltage variation	on pins BP0 to BP3	[6]	-	2.5	+10	mV
		on pins S0 to S43	[7]	-	2.5	+10	mV
R <sub>O</sub> output resistance	output resistance	V <sub>LCD</sub> = 7 V; on pins BP0 to BP3	[8]	-	0.9	5.0	kΩ
		V <sub>LCD</sub> = 7 V; on pins S0 to S43	[8]	-	1.5	6.0	kΩ

Power-down mode is enabled; I<sup>2</sup>C-bus or SPI-bus inactive. <sup>1</sup>/<sub>4</sub> bias; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; inputs at  $V_{SS}$  or  $V_{DD}$ ; default display prescale factor; I<sup>2</sup>C-bus or SPI-[1] [2] bus inactive.

[3]

bus inactive. Strongly linked to  $V_{LCD}$  voltage. See Figure 32. <sup>1</sup>/<sub>4</sub> bias; display enabled; LCD outputs are open circuit; RAM is all written with logic 1; default display prescale factor. The I<sup>2</sup>C-bus interface of PCA8546 is 5 V tolerant. Variation between any two backplanes on a given voltage level; static measured. Variation between any two segments on a given voltage level; static measured.

[4] [5] [6] [7]

Outputs measured one at a time. [8]

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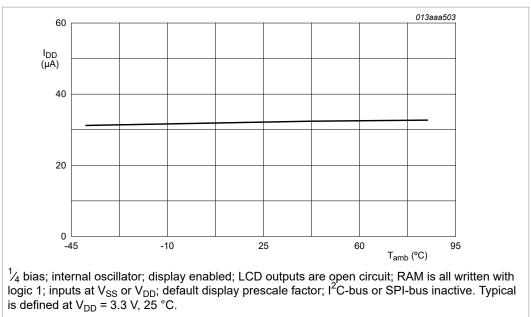
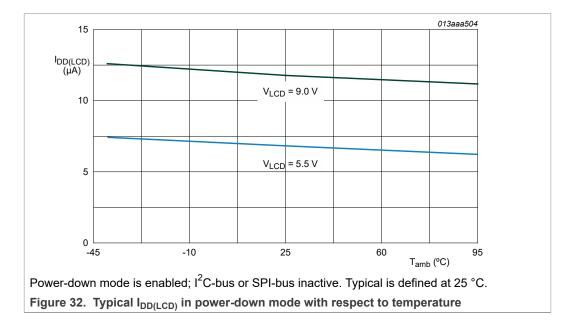
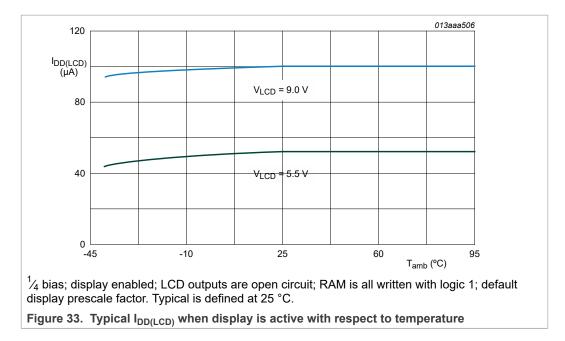


Figure 31. Typical I<sub>DD</sub> with respect to temperature



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# **13 Dynamic characteristics**

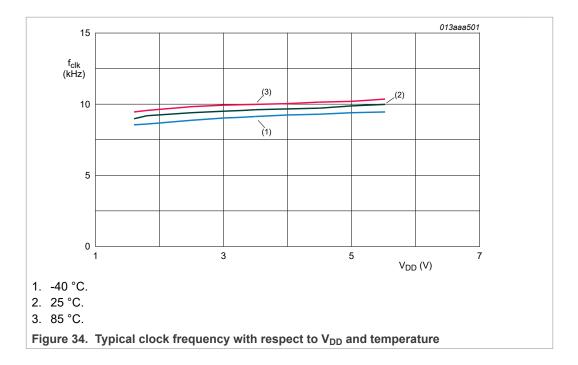
#### Table 31. Dynamic characteristics

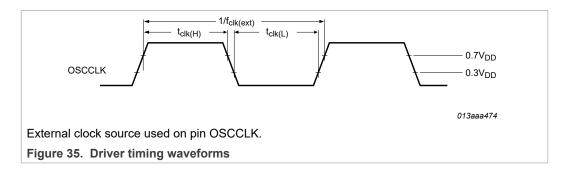
 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $V_{LCD}$  = 2.5 V to 9 V;  $T_{amb}$  = -40 °C to +95 °C; unless otherwise specified.

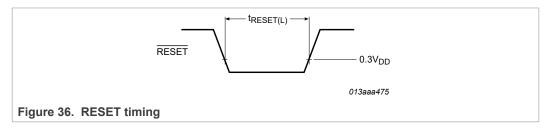
Symbol	Parameter	Conditionsoutput on pin OSCCLK; VDD = 3.3 V		Min	Тур	Max	Unit
f <sub>clk</sub>	clock frequency			7 800	9 600	11 040	Hz
f <sub>clk(ext)</sub>	external clock frequency	EFR = 0		-	-	250 000	Hz
t <sub>(RESET_N)</sub>	RESET_N pulse width	LOW time		400	-	-	ns
External c	lock source used on pin OSC	CLK		1			
t <sub>clk(H)</sub>	clock HIGH time			33	-	-	μs
$t_{clk(L)}$	clock LOW time			33	-	-	μs

[1] Frequency present on OSCCLK with default display frequency division factor.

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#### Table 32. Timing characteristics: I<sup>2</sup>C-bus

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +95 °C; unless otherwise specified. All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ . Timing waveforms see Figure 37.

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Pin SCL							
f <sub>SCL</sub>	SCL clock frequency		[1]	-	-	400	kHz

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#### Table 32. Timing characteristics: I<sup>2</sup>C-bus...continued

 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +95 °C; unless otherwise specified. All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ . Timing waveforms see Figure 37.

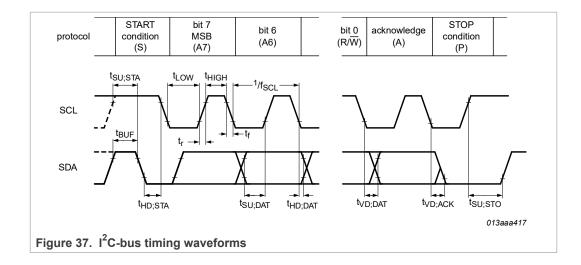
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
t <sub>LOW</sub>	LOW period of the SCL clock			1.3	-	-	μs
t <sub>HIGH</sub>	HIGH period of the SCL clock			0.6	-	-	μs
Pin SDA				1		1	
t <sub>SU;DAT</sub>	data set-up time			100	-	-	ns
t <sub>HD;DAT</sub>	data hold time			0	-	-	ns
Pins SCL	and SDA					1	!
t <sub>BUF</sub>	bus free time between a STOP and START condition			1.3	-	-	μs
t <sub>SU;STO</sub>	set-up time for STOP condition			0.6	-	-	μs
t <sub>HD;STA</sub>	hold time (repeated) START condition			0.6	-	-	μs
t <sub>SU;STA</sub>	set-up time for a repeated START condition			0.6	-	-	μs
t <sub>r</sub>	rise time of both SDA and SCL	f <sub>SCL</sub> = 400 kHz		-	-	0.3	μs
	signals	f <sub>SCL</sub> = 100 kHz		-	-	1.0	μs
t <sub>f</sub>	fall time of both SDA and SCL signals			-	-	0.3	μs
t <sub>VD;ACK</sub>	data valid acknowledge time		[2]	0.6	-	-	μs
t <sub>VD;DAT</sub>	data valid time		[3]	0.6	-	-	μs
C <sub>b</sub>	capacitive load for each bus line			-	-	400	pF
t <sub>SP</sub>	pulse width of spikes that must be suppressed by the input filter		[4]	-	-	50	ns

The minimum SCL clock frequency is limited by the bus time-out feature, which resets the serial bus interface if either the SDA or SCL is held LOW for a [1] minimum of 25 ms. The bus time-out feature must be disabled for DC operation.

[2] [3] t<sub>VD;ACK</sub> = time for acknowledgement signal from SCL LOW to SDA output LOW.

 $t_{VD;DAT}$  = minimum time for valid SDA output following SCL LOW.

Input filters on the SDA and SCL inputs suppress noise spikes of less than 50 ns. [4]

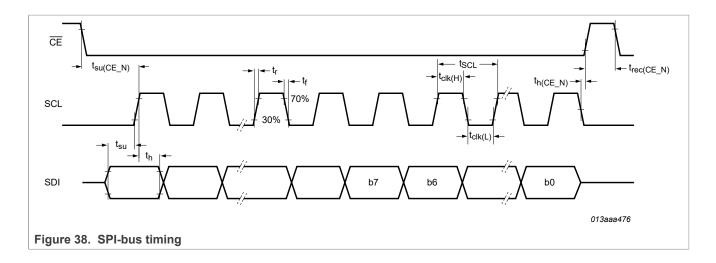


#### Table 33. Timing characteristics: SPI-bus

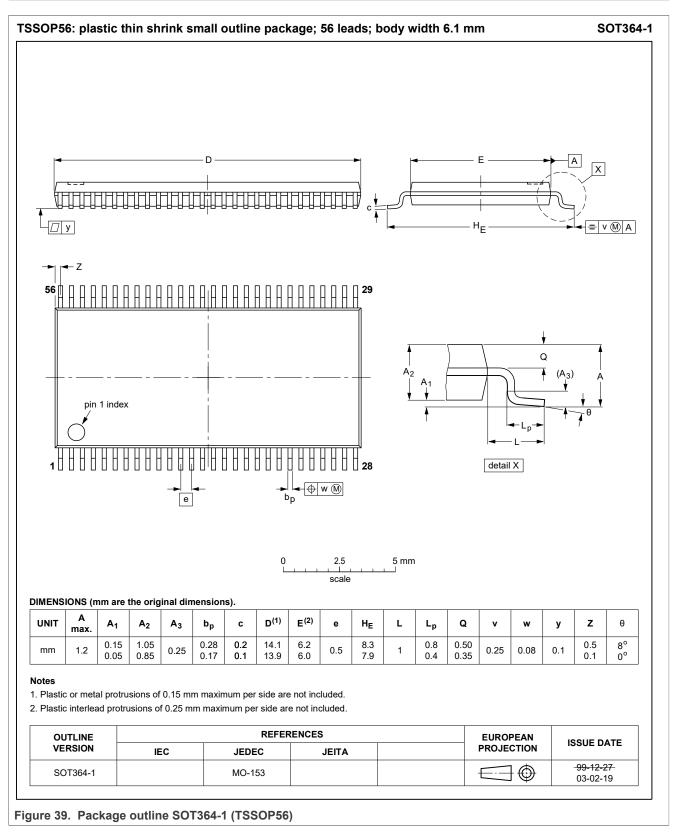
 $V_{DD}$  = 1.8 V to 5.5 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +95 °C. All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ . Timing waveforms see Figure 38.

Symbol	Parameter	Conditions	V <sub>DD</sub> < 2	2.7 V	$V_{DD} \ge 2$	2.7 V	Unit	
			Min	Мах	Min	Мах		
f <sub>clk(SCL)</sub>	SCL clock frequency		-	2	-	5	MHz	
t <sub>SCL</sub>	SCL time		500	-	200	-	ns	
t <sub>clk(H)</sub>	clock HIGH time		200	-	80	-	ns	
t <sub>clk(L)</sub>	clock LOW time		200	-	80	-	ns	
t <sub>r</sub>	rise time	for SCL signal	-	100	-	100	ns	
t <sub>f</sub>	fall time	for SCL signal	-	100	-	100	ns	
t <sub>su(CE_N)</sub>	CE_N set-up time		150	-	80	-	ns	
t <sub>h(CE_N)</sub>	CE_N hold time		0	-	0	-	ns	
t <sub>rec(CE_N)</sub>	CE_N recovery time		100	-	100	-	ns	
t <sub>su</sub>	set-up time	set-up time for SDI data	10	-	5	-	ns	
t <sub>h</sub>	hold time	hold time for SDI data	25	-	10	-	ns	

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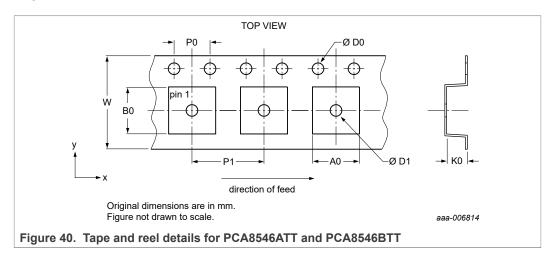
## 14 Package outline



## **15 Handling information**

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

# **16 Packing information**



### 16.1 Tape and reel information

Symbol	Description	Value	Unit		
Compartme	ents	·	· · · · ·		
A0	pocket width in x direction	8.65 to 8.9	mm		
B0	pocket width in y direction	14.4 to 15.8	mm		
K0	pocket depth	1.5 to 1.8	mm		
P1	pocket hole pitch	12	mm		
D1	pocket hole diameter	1.5 to 2.05	mm		
Overall dim	ensions		1		
W	tape width	24	mm		
D0	sprocket hole diameter	1.5 to 1.55	mm		
P0	sprocket hole pitch	4 mm			

# 17 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow* soldering description".

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#### 17.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

#### 17.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

#### 17.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

#### 17.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 41</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board

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• Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 35 and Table 36

Package thickness (mm)	Package reflow temperature (°C)							
	Volume (mm <sup>3</sup> )							
	< 350	≥ 350						
< 2.5	235	220						
≥ 2.5	220	220						

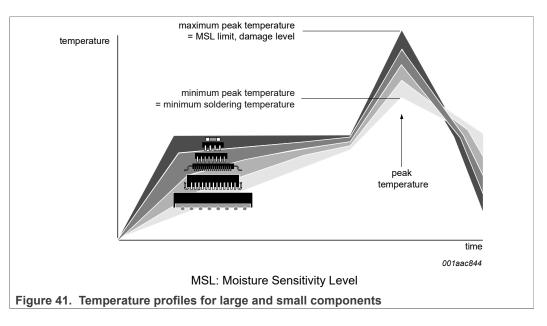
#### Table 35. SnPb eutectic process (from J-STD-020D)

#### Table 36. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflo	Package reflow temperature (°C) Volume (mm³)								
	Volume (mm <sup>3</sup> )									
	< 350	350 to 2000	> 2000							
< 1.6	260	260	260							
1.6 to 2.5	260	250	245							
> 2.5	250	245	245							

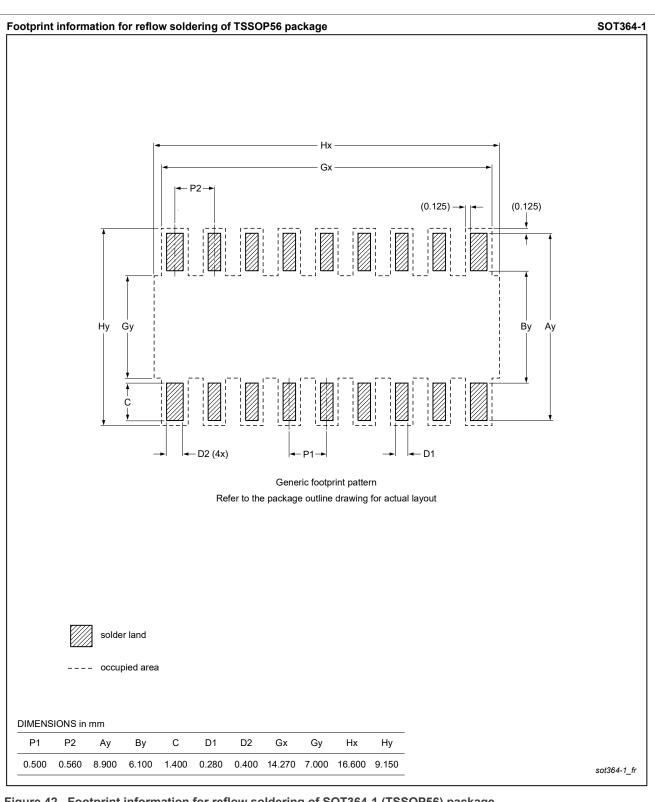
Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see <u>Figure 41</u>.



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For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.



# 18 Footprint information for reflow soldering

Figure 42. Footprint information for reflow soldering of SOT364-1 (TSSOP56) package

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# **19** Appendix

### 19.1 LCD segment driver selection

Type name	Num	ber o	felem	ents a	at MU	X	_	V <sub>DD</sub> (V)	V <sub>LCD</sub> (V)	f <sub>fr</sub> (Hz)	V <sub>LCD</sub> (V)	V <sub>LCD</sub> (V)
	1:1	1:2	1:3	1:4	1:6	1:8	1:9				charge pump	temperature compensat.
PCA8561AHN <sup>[1]</sup>	18	36	54	72	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256 <sup>[2]</sup>	Ν	N -
PCA8561BHN <sup>[1]</sup>	18	36	54	72	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256 <sup>[2]</sup>	N	N -
PCF8566TS	24	48	72	96	-	-	-	2.5 to 6	2.5 to 6	69	Ν	N -
PCF85162T	32	64	96	128	-	-	-	1.8 to 5.5	2.5 to 6.5	82	Ν	N -
PCA85162T	32	64	96	128	-	-	-	1.8 to 5.5	2.5 to 8	110	Ν	N -
PCA85262ATT	32	64	96	128	-	-	-	1.8 to 5.5	2.5 to 8	200	N	N -
PCF8551ATT <sup>[1]</sup>	36	72	108	144	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 128 <sup>[2]</sup>	N	N -
PCF8551BTT <sup>[1]</sup>	36	72	108	144	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 128 <sup>[2]</sup>	N	N -
PCA8551ATT <sup>[1]</sup>	36	72	108	144	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256 <sup>[2]</sup>	Ν	N -
PCA8551BTT <sup>[1]</sup>	36	72	108	144	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256 <sup>[2]</sup>	N	N -
PCF85176T	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	82	N	N -
PCA85176T	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 8	110	Ν	N -
PCA85276ATT	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 8	200	N	N -
PCF85176H	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	82	N	N -
PCA85176H	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 8	82	Ν	N -
PCF8553ATT <sup>[1]</sup>	40	80	120	160	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 128 <sup>[2]</sup>	Ν	N -
PCF8553BTT <sup>[1]</sup>	40	80	120	160	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 128 <sup>[2]</sup>	N	N -
PCA8553ATT <sup>[1]</sup>	40	80	120	160	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256 <sup>[2]</sup>	N	N -
PCA8553BTT <sup>[1]</sup>	40	80	120	160	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256 <sup>[2]</sup>	Ν	N -
PCA8546ATT <sup>[1]</sup>	-	-	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Ν	N -
PCA8546BTT <sup>[1]</sup>	-	-	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	N	N -
PCA8547AHT <sup>[1]</sup>	44	88	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCA8547BHT <sup>[1]</sup>	44	88	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup> -
PCF85134HL	60	120	180	240	-	-	-	1.8 to 5.5	2.5 to 6.5	82	N	N -

#### Table 37. Selection of LCD segment drivers

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Type name	Num	nber of	f elem	ients /	at MU	X		V <sub>DD</sub> (V)	V <sub>LCD</sub> (V)	f <sub>fr</sub> (Hz)	V <sub>LCD</sub> (V)	V <sub>LCD</sub> (V)
	1:1	1:2	1:3	1:4	1:6	1:8	1:9				charge pump	temperature compensat.
PCA85134H	60	120	180	240	-	-	-	1.8 to 5.5	2.5 to 8	82	Ν	N
PCA8543AHL	60	120	-	240	-	-	-	2.5 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y
PCF8545ATT <sup>[1]</sup>	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 5.5	60 to 300 <sup>[2]</sup>	N	Ν
PCF8545BTT <sup>[1]</sup>	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 5.5	60 to 300 <sup>[2]</sup>	N	Ν
PCF8536AT <sup>[4]</sup>	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	N	Ν
PCF8536BT <sup>[4]</sup>	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	N	Ν
PCA8536AT <sup>[4]</sup>	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	N	Ν
PCA8536BT <sup>[4]</sup>	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	N	Ν
PCF8537AH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCF8537BH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCA8537AH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCA8537BH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCA9620H	60	120	-	240	320	480	-	2.5 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCA9620U	60	120	-	240	320	480	-	2.5 to 5.5	2.5 to 9	60 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCF8552DUG <sup>[1]</sup>	36	72	108	144	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 128 <sup>[2]</sup>	N	Ν
PCA8552DUG <sup>[1]</sup>	36	72	108	144	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256 <sup>[2]</sup>	Ν	Ν
PCF8576DU	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	77	N	Ν
PCF8576EUG	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	77	N	Ν
PCA8576FUG <sup>[1]</sup>	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 8	200	N	Ν
PCF85133U	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 6.5	82, 110 <sup>[5]</sup>	N	N
PCA85133U	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 8	82, 110 <sup>[5]</sup>	N	N
PCA85233U	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 8	150, 220 <sup>[5]</sup>	N	N
PCA8530DUG <sup>[1]</sup>	102	204	-	408	-	-	-	2.5 to 5.5	4 to 12	45 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>
PCF85132U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	60 to 90 <sup>[2]</sup>	N	N

#### Table 37 Selection of LCD nont driv

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Type name	Num	ber of	f elem	nents a	at MU	X		V <sub>DD</sub> (V)	$V_{LCD}$ (V)	f <sub>fr</sub> (Hz)	V <sub>LCD</sub> (V)	V <sub>LCD</sub> (V)	1
	1:1	1:2	1:3	1:4	1:6	1:8	1:9				charge pump	temperature compensat.	
PCA85132U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	60 to 90 <sup>[2]</sup>	Ν	Ν	
PCA85232U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	117 to 176 <sup>[2]</sup>	N	Ν	
PCF8538UG <sup>[1]</sup>	102	204	-	408	612	816	918	2.5 to 5.5	4 to 12	45 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>	
PCA8538UG	102	204	-	408	612	816	918	2.5 to 5.5	4 to 12	45 to 300 <sup>[2]</sup>	Y	Y <sup>[3]</sup>	

#### Table 37. Selection of LCD segment drivers...continued

In development.
 Can be selected by command.
 Extra feature: Temperature sensor.
 Extra feature: 6 PWM channels.
 Can be selected by pin configuration.

## **20** Abbreviations

Table 38. Abbrev	viations
Acronym	Description
CDM	Charged-Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DC	Direct Current
EMC	ElectroMagnetic Compatibility
EPROM	Erasable Programmable Read-Only Memory
ESD	ElectroStatic Discharge
НВМ	Human Body Model
I <sup>2</sup> C	Inter-Integrated Circuit bus
IC	Integrated Circuit
LCD	Liquid Crystal Display
LSB	Least Significant Bit
MSB	Most Significant Bit
MSL	Moisture Sensitivity Level
MUX	Multiplexer
OTP	One Time Programmable
РСВ	Printed-Circuit Board
POR	Power-On Reset
RC	Resistance-Capacitance
RAM	Random Access Memory
RGB	Red Green Blue
RMS	Root Mean Square
SCL	Serial CLock line
SDA	Serial DAta line
SPI	Serial Peripheral Interface

### **21 References**

- [1] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [2] JESD22-C101 Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [3] JESD78 IC Latch-Up Test
- [4] UM10569 Store and transport requirements

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# 22 Revision history

	5	1		
Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA8546 v.2	20210929	Product data sheet	PCN202102010F01	PCA8546 v.1
Modifications:	Removed Marki		•	ply with NXP
PCA8546 v.1	20131113	Product data sheet	-	-

#### Table 39. Revision history

# 23 Legal information

#### 23.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

Please consult the most recently issued document before initiating or completing a design. [1]

[2] [3] The term 'short data sheet' is explained in section "Definitions".

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